TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MH4040FK

12-Stage Ripple-Carry Binary Counter

The TC7MH4040FK is an advanced high speed CMOS 12-stage ripple-carry binary counter fabricated with silicon gate $\rm C^2MOS$ technology.

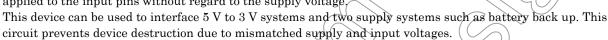
It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

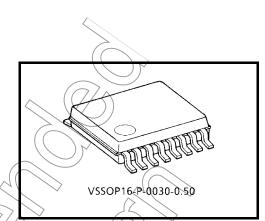
Setting CLR to high resets the counter to low.

A negative transition on the $\overline{\mbox{CK}}$ input brings one increment into the counter.

This counter provides all divided output stages, and at Q12, a 1/4096 divided frequency will be output.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage.

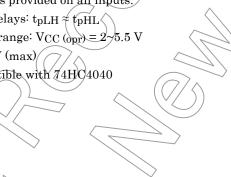




Weight: 0.02 g (typ.)

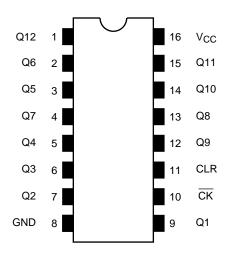
Features

- High speed: $f_{max} = 210 \text{ MHz}$ (typ.) (V_{CC} = 5 V)
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)} (T_a = 25 \text{°C})$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% (V_{CC})$
- Power down protection is provided on all inputs.
- Balanced propagation delays: t_{pLH} ≈ t_{pHL}
- Wide operating voltage range: V_{CC} (opr) = $2 \sim 5.5 \text{ V}$
- Low noise: $V_{OLP} = 1.5 \text{ V (max)}$
- Pin and function compatible with 74HC4040



Pin Assignment (top view)

IEC Logic Level

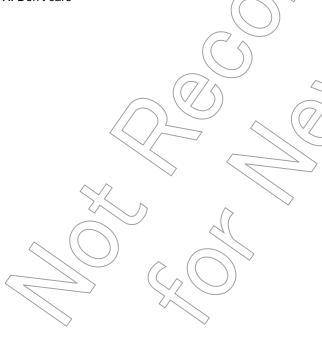


		_
	RCTR 12	(9) Q1
	_0	(7) Q2
(11)		(6) O3
CLR (117)	CT = 0/	1 (5)
		(3) Q4
<u> </u>		(2) Q5
CK (10)	>+CT 💢))	
		(13) Q7
	(\bigcirc / \land)	
		(12) Q9
		(14) Q10
		(15)
((—— (J11
	11	(1) Q12
		/ ~ \

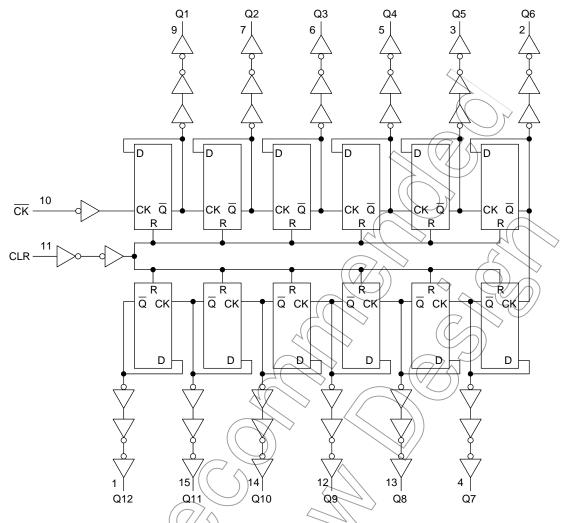
Truth Table

CK	CLR	Outputs
Х	Н	All outputs = "L"
	L	No change
	L	Advance to next state





System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	-0.5~7.0	V
DC input voltage	VIN	-0.5~7.0	V
DC output voltage	Vout	-0.5~V _{CC} + 0.5	V
Input diode current	< hk	-20	mA
Output diode current	lok	±20	mA
DC output current	TUOI	±25	mA
DC VCC/ground current	Jec	±100	mA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, may lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit	
Supply voltage	y voltage V _{CC} 2.0~5.5		V	
Input voltage	V _{IN}	0~5.5	V	
Output voltage	V _{OUT}	0~V _{CC}	V	
Operating temperature	T _{opr}	-40~85	°C	
Input rise and fall time	dt/dv	$0\sim100 \ (V_{CC}=3.3\pm0.3 \ V)$	ns/V	
input rise and rail time	ui/uv	0~20 (V _{CC} = 5 ± 0.5 V)		

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics		0	Symbol Test Condition		Ta = 26°C Ta = -40~85			0~85°C	Unit		
		Symbol			Aec (A)	Min	Тур.	Max	Min	Max	Unit
					2.0	1.50	-((\ \ \	1.50	_	
Input voltage	High level	V _{IH}	-		3.0~5.5	V _{CC} × 0.7			V _{CC} × 0.7	_	V
input voltage					2.0	\	(4)	0.50	_	0.50	V
Low leve	Low level	V _{IL}		#()	3.0~5.5		_	V _{CC} × 0.3	_	$\begin{array}{c} V_{CC} \\ \times \ 0.3 \end{array}$	
					2.0	1.9	2.0		1.9		
	High level	ligh level V _{OH}	VIN VIH	10H = −50 μA	3.0	2.9	3.0	_	2.9		
				1	4,5	4.4	4.5	_	4.4		
				I _{OH} = -4 mA	3.0	2.58	_	_	2.48		
Output				I _{OH} = -8 mA	4.5	3.94	_		3.80		V
voltage		2			2.0		0	0.1	_	0.1	v
			7	1 _{OL} = 50 μA	3.0		0	0.1	_	0.1	
Lo	Low level	Low level V _{OL}	V _{IN} = V _{IH}		4.5	_	0	0.1	_	0.1	
			toL = 4 mA	3.0	_	_	0.36	_	0.44		
				I _{OL} = 8 mA	4.5	_	_	0.36	_	0.44	
Input leakage	current	I _{IN}	V _{IN} =5.5 \	V or GND	0~5.5	_	_	±0.1	_	±1.0	μΑ
Quiescent sup	ply current	Icc	VIN = VCC	or GND	5.5	_	_	4.0	_	40.0	μΑ

Timing Requirements (Input: $t_r = t_f = 3 \text{ ns}$)

)				r	
Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40~85°C	Unit
Characteristics	Symbol	7 est Condition	V _{CC} (V)	Тур.	Limit	Limit	Oill
Minimum pulse width	t _w (L)	_	3.3 ± 0.3	_	5.0	5.0	ns
(CK)	t _{w (H)}	_	5.0 ± 0.5	_	5.0	5.0	113
Minimum pulse width	t 4.0		3.3 ± 0.3	_	5.0	5.0	nc
(CLR)	t _{w (H)}	_	5.0 ± 0.5	_	5.0	5.0	ns
Minimum removal time	t	_	3.3 ± 0.3	_	5.0	5.0	ns
	trem		5.0 ± 0.5	_	5.0	5.0	115

AC Characteristics (Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Symbol Test Condition				Ta = 25°C			Ta = -40~85°C		
Characteristics	Symbol	rest Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Unit	
			3.3 ± 0.3	15	_	7.5	11.9	1.0	14.0		
Propagation delay time	t _{pLH}		3.5 ± 0.5	50	_	10.0	15.4	1.0	17.5	ns	
(CK - Q1)	tpHL	_	5.0 ± 0.5	15	_	4.8	7.3	1.0	8.5	113	
			3.0 ± 0.3	50	_	6.3	9.3	1.0	10.5		
Propagation delay time	A+ .	_	3.3 ± 0.3	50	_	2.4	44	1.0	5.0	ns	
$(Q_n - Q_n + 1)$	Δt_{pd}		5.0 ± 0.5	50	~	1.6	3.1	1.0	3.5	115	
	t _{pHL}	_	3.3 ± 0.3	15	-	8.3	12.8	1.0	15.0	- ns	
Propagation delay time				50	-((10.8	16.3	1.0	18.5		
(CLR - Q)			5.0 ± 0.5	15		5.5	8.6	1.0	10.0		
				50 <	1(-/	7.1	10.6	1.0	12.0		
			3.3 ± 0.3	15	75	140	- /	75	Ť		
Maximum clock frequency	f			50//	555	80	+(50	_	MHz	
Maximum clock frequency	f _{max}	_	5.0 ± 0.5	15	150	210	(+)	(125)) _	IVII IZ	
			3.0 ± 0.3	50	95	125	/ / (> 80	_		
Input capacitance	C _{IN}	-	- 4(_	4	19)	_	10	pF	
Power dissipation capacitance	C _{PD}			(Note)	_ (21/		_	_	pF	

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

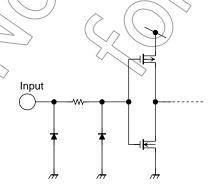
Average operating current can be obtained by the equation:

 $I_{CC \text{ (opr)}} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

Noise Characteristics (Input: t_r = t_f = 3 ns)

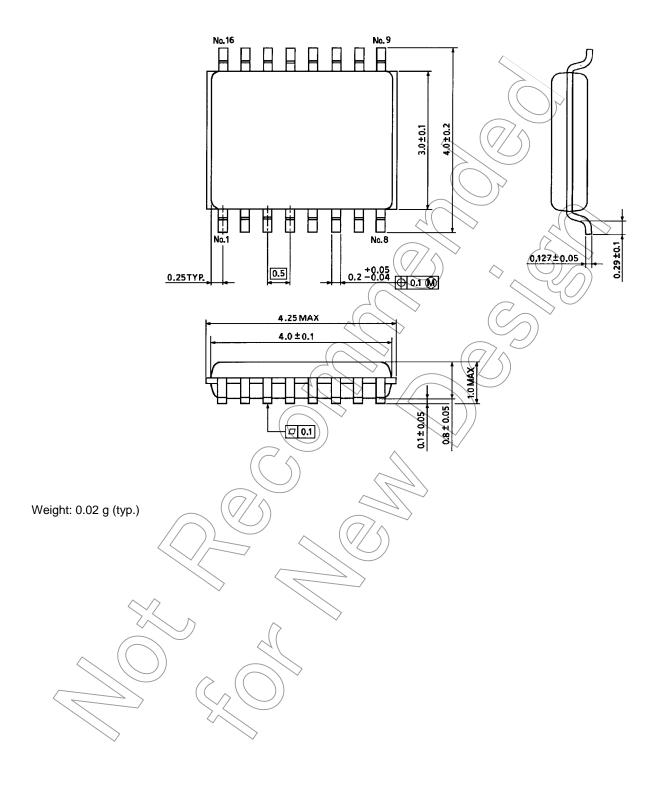
Characteristics	Symbol	Test Condition	Ta =		25°C	Unit
Gildiatellates	Symbol	rest Condition	V _{CC} (V)	Тур.	Limit	Offic
Quiet output maximum dynamic VoL	VOLR	C _L = 50 pF	5.0	1.2	1.5	V
Quiet output minimum dynamic V _{QL}	VOLV	C _L = 50 pF	5.0	-1.2	-1.5	V
Minimum high level dynamic input voltage V _{IH}	AHD	C _L = 50 pF	5.0	_	3.5	V
Minimum low level dynamic input voltage V _{IL}	V _{ILD}	C _L = 50 pF	5.0	_	1.5	V

Input Equivalent Circuit



5 2007-10-19

Package Dimensions



6 2007-10-19

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